Yes

1000

None

ppm



PART NO. TG0603E0020M24

1.1 Technology Data	Symbol		Value	Unit
Maximum allowable continuous AC voltage at 50-60Hz	V _{RMS}		~	V
Maximum allowable continuous DC voltage	V _{DC}		24	V
Trigger Voltage	VT		300	V
Typical capacitance value measured at 1MHz	С		0.15	pF
Typical capacitance value tolerance			+0.15	pF
Maximum ESD allowable clamping Voltage*2	V_{CLAMP}		50	V
Leakage current at V _{DC*3} (At initial state)	I _{LDC}	<	0.1	uA
1.2 Reference Data				
Response time	T _{rise}	<	1	ns
Operation ambient temperature			-40∼ +85	$^{\circ}\!\mathbb{C}$
Storage temperature			-40∼+125	$^{\circ}\!\mathbb{C}$
ESD testing	IEC61000-4-2		level 4	
1.3 Other Data				
Body			ZnO	
End termination			Ag/Ni/Sn	
Packaging			Reel	
Complies with Standard			IEC61000-4-2	

Notes:

LeadFree

Marking

 $\,st\,$ 1 The varistor voltage was measured at 1 mA current

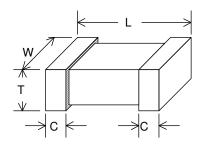
Complies with RoHs Standard

- $\,*\,$ 2 The Clamping voltage was measured at 8*20 us waveform and 1A pulse current
- $\ensuremath{\boldsymbol{\ast}}$ 3 The Leakage current was measured at working voltage.
- $\,st\,$ 4 The Cp was measured with zero volt bias 1Vrms at 1MHZ

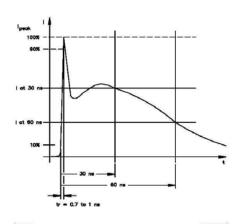


2.Size

Unit: mm	0402
L	1.00±0.12
W	0.50±0.10
Т	0.50±0.10
С	0.25±0.15



3. ESD Wave Form



IEC61000-4-2 Standards

SEVERITY LEVEL	AIRDIRCHARGE	DIRECT DISCHARGE
1	2 KV	2 KV
2	4 KV	4 KV
3	8 KV	6 KV
4	15 KV	8 KV

IEC 61000-4-2 Compliant ESD Current Pulse Waveform

4. Environment Reliability Test

Characteristic	Test method and description					
High Temperature Storage	The specimen shall be subjected to $125 \pm 2^{\circ}\text{C}$ for 1000 ± 12 hours in a thermostatic bath without load and then stored at room temperature and normal humidity for 1 to 2 hours. The change of varistor voltage shall be within 10 $\%$.					
	The temperature cycle of specified	Step	Temperature	Period		
	temperature shall be repeated five times and then stored at room temperature and	1	-40±3℃	30Min±3		
Temperature Cycle	normal humidity for one or two hours. The	2	Room Temperature	1 hour		
	change of varistor voltage shall be within 10 % and mechanical damage shall be	3	125±3℃	30Min±3		
	examined.	4	Room Temperature	1 hour		
High Temperature Load	After being continuously applied the maximum allowable voltage at $85 \pm 2^{\circ}$ C for 1000 ± 2 hours, the specimen shall be stored at room temperature and normal humidity for one or two hours, the change of varistor voltage shall be within 10%.					
Damp Heat Load/ Humidity Load	The specimen should be subjected to $40 \pm 2^{\circ}C$, 90 to 95 % RH environment, and the maximum allowable voltage applied for 1000 hours, then stored at room temperature and normal humidity for one or two hours. The change of varistor voltage shall be within 10%					
Low Temperature Storage	The specimen should be subjected to -40 \pm 2°C, without load for 500 hours and then stored at room temperature for one or two hours. The change of varistor voltage shall be within 10 $\%$					

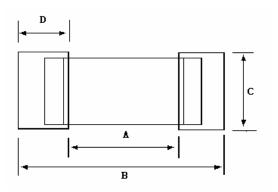


5. Soldering Recommendations

5.1 Recommended solder pad layout

(Unit: mm)

	Α	В	С	D
0402	0.4~0.6	1.4~1.8	0.5~0.6	0.6~1.2
0603	0.9~1.2	2.7~3.2	0.7~1.0	0.9~1.2



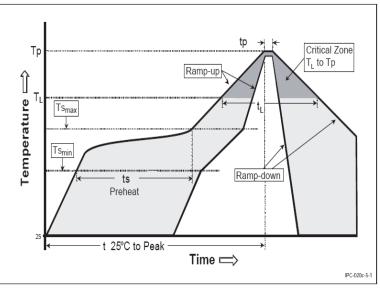
5.2 The SIR test of the solder paste shall be done (Based on JIS-Z-3284)

5.3 Steel plate and foot distance printing

Foot distance printing (mm)	Steel Plate thickness (mm)
> 0.65mm	0.18mm
0.65mm~0.5mm	0.15mm
0.50mm~0.40mm	0.12mm
>=0.40 mm	0.10mm

5.4The IR reflow and temperature of Soldering for Pb Free

Reflow Co	ndition	Lead–free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 – 180 secs
Average ra	ımp up rate (LiquidusTemp k	3°C/second max
T _{S(max)} to T _L	- Ramp-up Rate	5°C/second max
Reflow	-Temperature (T _L) (Liquidus)	217°C
Reliow	-Time (min to max) (t _s)	60 – 150 seconds
Peak Temp	erature (T _P)	260 +0/-5°C
Time within Temperatu	n 5°C of actual peak re (t _p)	20 - 40 seconds
Ramp-dow	n Rate	6°C/second max
Time 25°C	to peak Temperature (T _P)	8 minutes Max.



Note that this product will be easily damaged by rapid heating, rapid cooling or local heating.

Do not give heat shock over 100°C in the process of soldering. We recommend to take preheating and gradual cooling

Soldering gun procedure

Note the follows, in case of using solder gun for replacement.

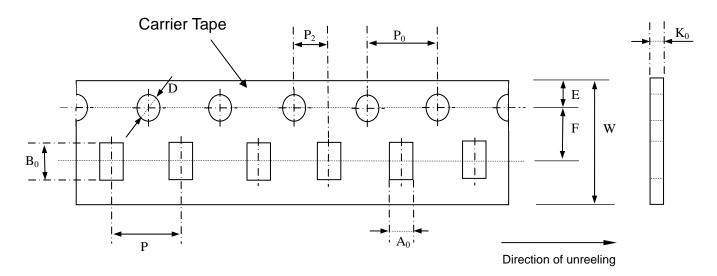
- 1) The tip temperature must be less than 280 for the period within 3 seconds by using soldering gun under 30W
- 2) The soldering gun tip shall not touch this product directly.

Soldering volume

Note that excess of soldering volume will easily get crack the body of this product.

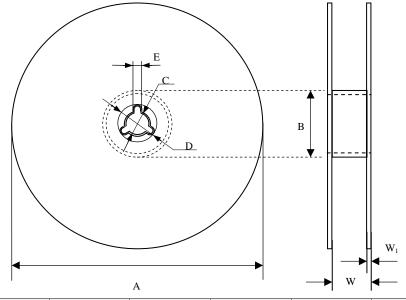


6. Packaging Specification



Symbol	A ₀ ±0.05	B ₀ ±0.05	K₀ ±0.05	D +0.10 -0.05	P ±0.10	P ₂ ±0.10	P ₀ ±0.10	W ±0.10	E ±0.10	F ±0.05
0402	0.62	1.12	0.60	1.55	2.00	2.00	4.00	8.00	1.75	3.50
0603	1.10	1.90	0.95	1.56	4.00	2.00	4.00	8.00	1.75	3.50

7.Reel Dimension



Symbol	Α	В	С	D	E	W	W ₁
0402	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.50	1.5±0.15
0603	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.50	1.5±0.15

8. Standard Packaging

Size	0402	0603
Pcs	10000	4000